

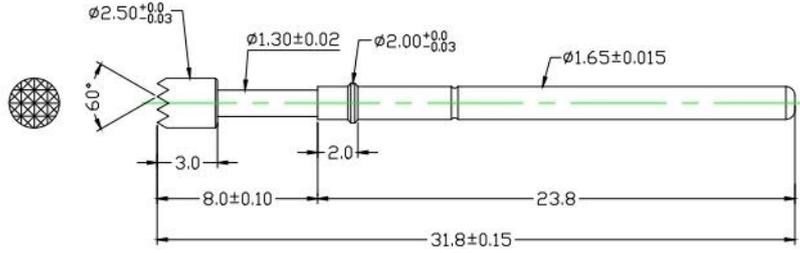
PCB 000 000 SF-PA1.65 BY 31.8-H2.5

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00 & 00	00, 0 00
00 00	5A
0 0	350g ± 50gf @ 00 4.0mm 00 0000
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SFENG





Materials(Plated) (材質與鍍層):
 Barrel(針套) : Brass(黃銅) , Au on Ni Plated
 Plunger(針軸) : BeCu(鈹銅) , Au on Ni Plated
 Spring(彈弓) : SWP (琴鋼線) , Au on Ni Plated

Specifications (技術要求):
 Current Rating(額定電流) : 5A
 Contact Resistance(接觸電阻) : 50mΩ
 Full Stroke(滿沖程) : 5.00mm
 Rated Stroke(額定沖程) : 4.00mm
 Spring Force(額定彈力) : 350±50gf@ load 4.00mm

				名称:		胜峰科技	
				SF-PA1.65X31.8-H2.5		说明:	
标记处数				更改文件号		1. 所有尺寸单位为mm	
设计				标准化		2. 未注图示尺寸公差:按GB1801-79 11级精度执行	
校对				审定		图样标记	
审核				制图		视图质量	
工艺				日期		比例	
				2019-8-29		/	
				共 1 页		第 1 页	
						图纸编号:	

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2. Customized design □ □□□ OEM □ □□□□□.
3. □□□ □□ □ □□ □□□ □□□ □□ □ □ □□□□.
4. □□□ □□□□ □□□□ □□□ □□ □□□□ □□ □ □ □□□□.

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□□□□□□ (□□) PCB, ICT, FCT □□□□ □□;

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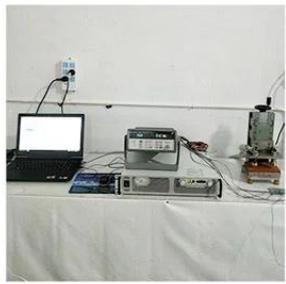
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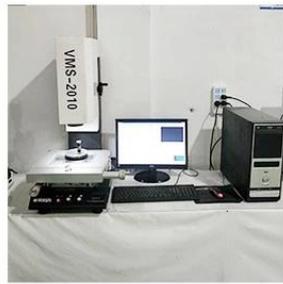
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1. Agilent current testing



2. Quadratic element



3. Load Curve Meter



4. Bond Test



5. Life Fatigue Test



6. Microscope

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Standard products will be delivered out within 3 days. Customized products will be sent out within 15 days.

